



■ Dustproof Enclosure

■ MAXIMUM RATINGS

(Ta = 25 °C)

Item		Symbol	Value
Input	Forward DC Current	I_F	50mA
	Forward DC Current Derating ^{*1}	$\Delta I_F/^\circ\text{C}$	-0.33mA/°C
	Reverse DC Voltage	V_R	5V
	Pulse Forward Current	I_{FP}	600mA ^{*2}
Output	C-E Voltage	V_{CE0}	30V
	E-C Voltage	V_{ECO}	5V
	Collector Current	I_C	50mA
	Collector Power Dissipation	P_C	75mW
	Collector Power Dissipation Derating ^{*1}	$\Delta P_C/^\circ\text{C}$	-1mW/°C
Operating Temperature Range		T_{OPR}	-25~+85 °C
Storage Temperature Range		T_{STG}	-40~+85 °C

■ MECHANICAL CHARACTERISTICS

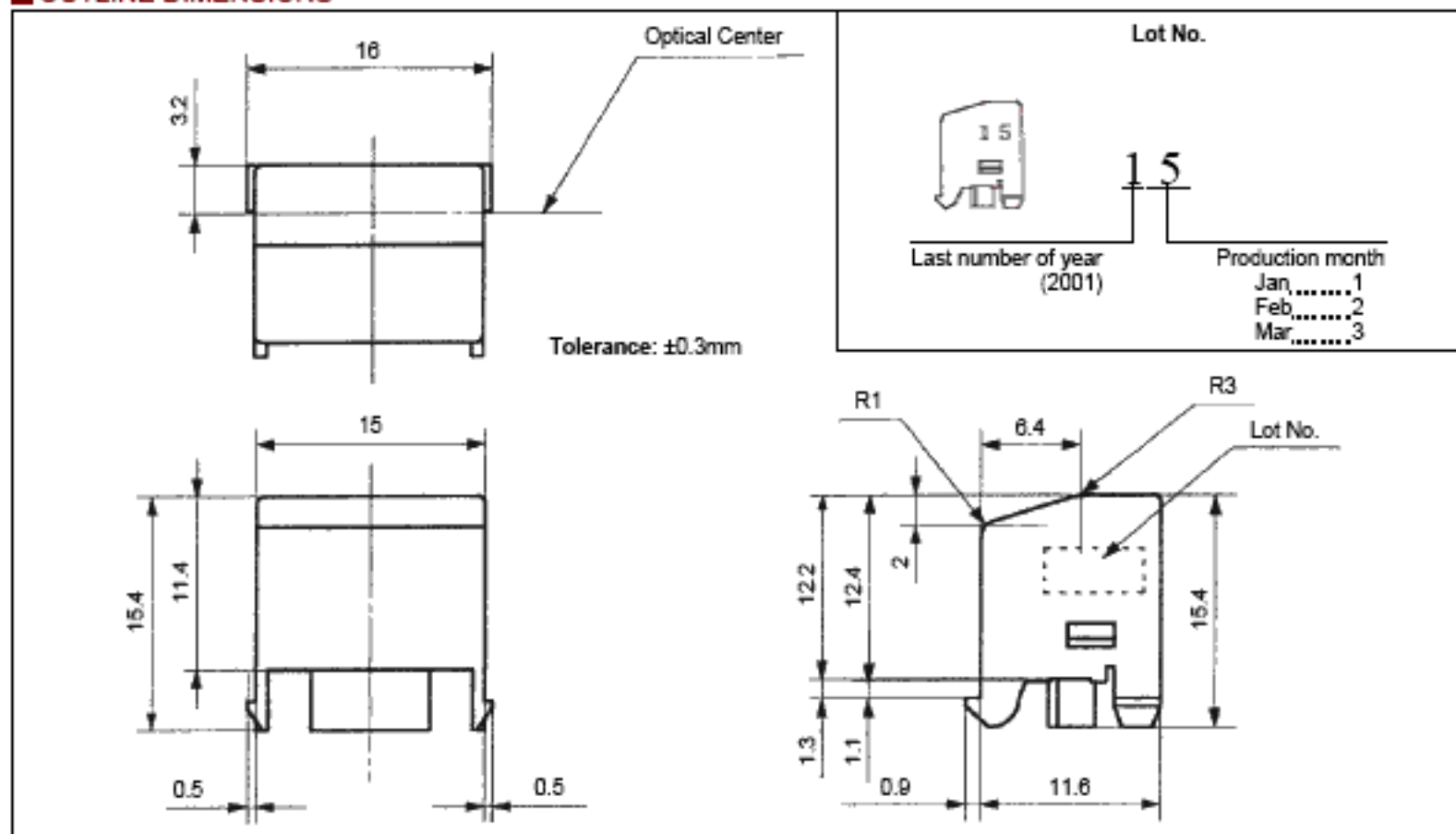
Vibration Resistance	To withstand 10~55~10Hz, 1.5mm amplitude and 1 minute sweep time in X, Y and Z directions, each for 2 hours.
Shock Resistance	294m/S ² (30G) or more.

■ ELECTRICAL/OPTICAL CHARACTERISTICS

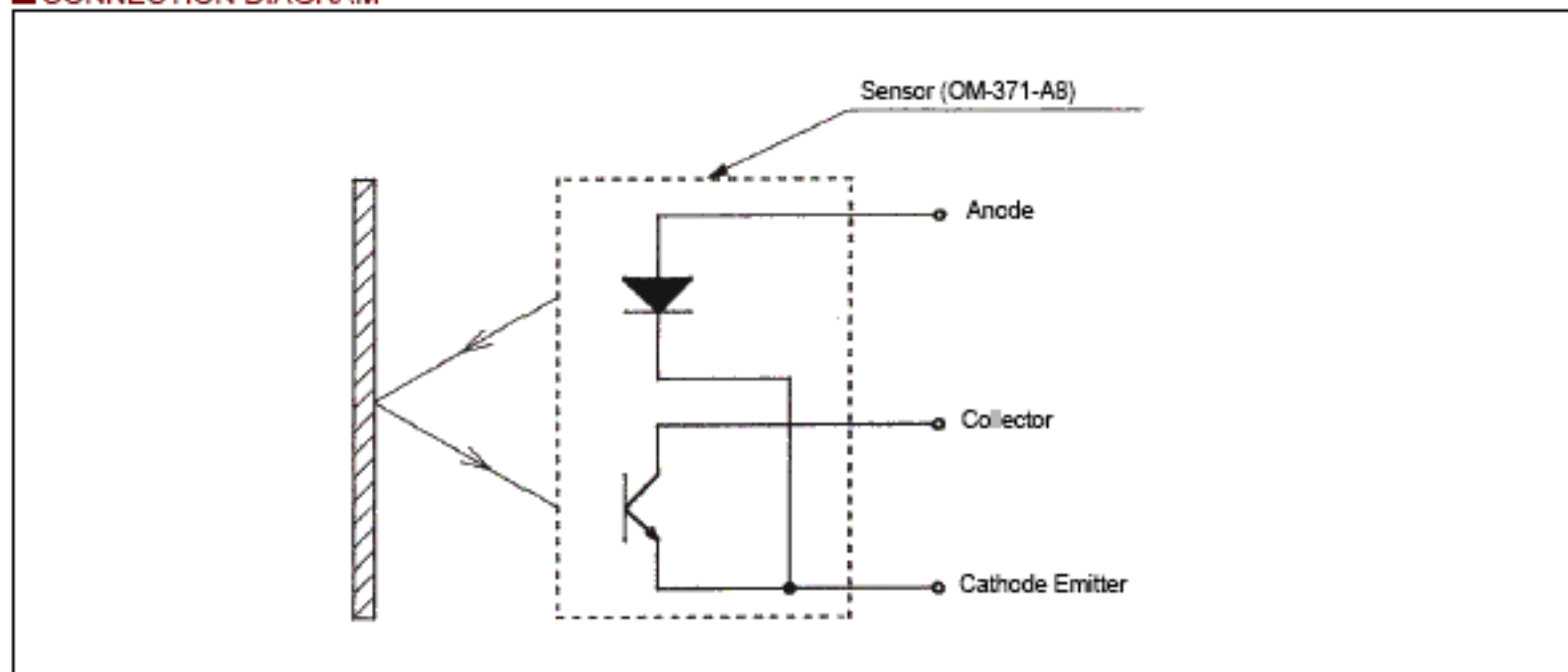
(Ta = 25 °C)

Item		Symbol	Conditions	Min	Typ	Max	Unit	
Input	Forward Voltage	V_F	$I_F = 10\text{mA}$	1.00	1.15	1.3	V	
	Reverse Voltage	I_R	$V_R = 5\text{V}$	-	-	10	μA	
	Peak Wavelength	λ_p	$I_F = 20\text{mA}$		940	-	nm	
Output	Off-State Collector Current	I_{CEO}	$V_{CE} = 24\text{V}$ $E = 0$	-	0.005	0.1	μA	
	Peak Wavelength	λ_p	-	-	870	-	nm	
Coupled	Light Current		I_L^{*3}	$V_{CE} = 5\text{V}^{*4}$ $I_F = 20\text{mA}$ $L = 6\text{mm}$	80	-	1,400	μA
	Leak Current		I_{LEAK}^{*3}	$V_{CE} = 5\text{V}$ $I_F = 20\text{mA}$	-	500	-	nA
	Switching Time	Rise Time	t_r	$V_{CC} = 5\text{V}$ $I_C = 2\text{mA}$ $R_L = 100\Omega$	-	6	-	μs
		Fall Time	t_f		-	6	-	μs

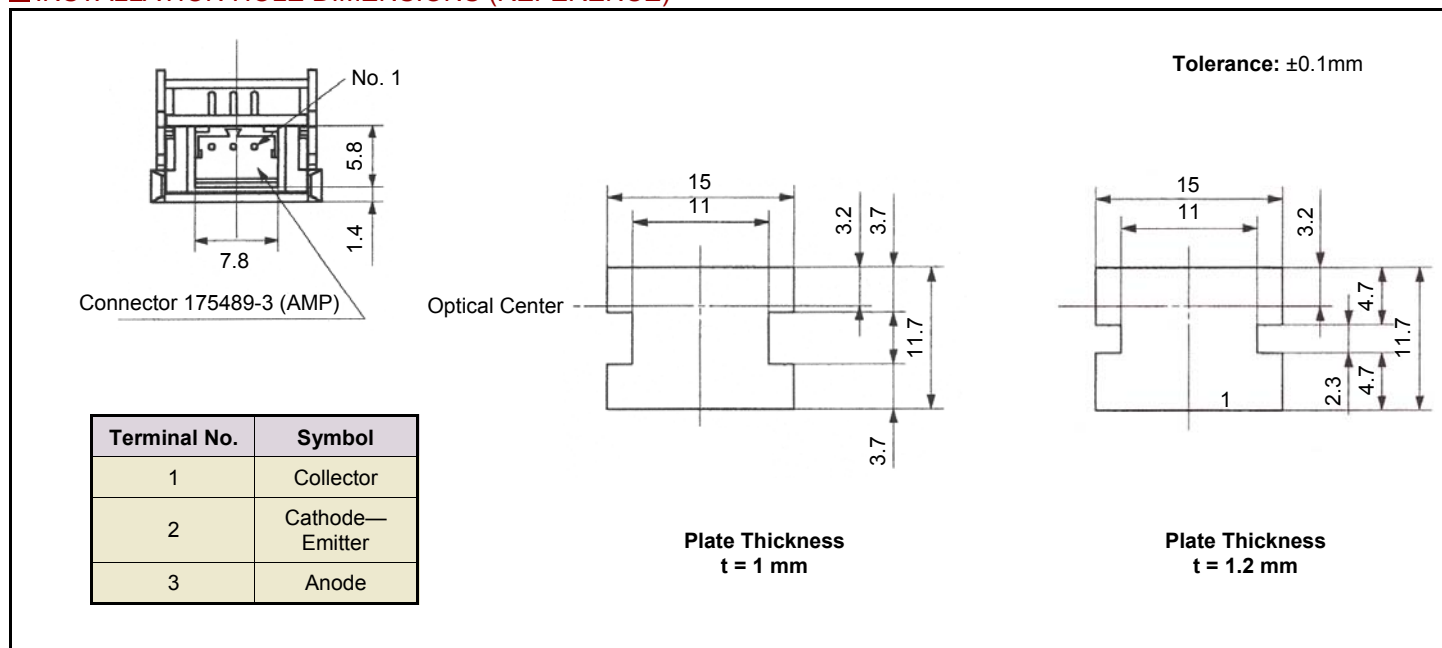
OUTLINE DIMENSIONS



CONNECTION DIAGRAM



■ INSTALLATION HOLE DIMENSIONS (REFERENCE)



■ PARTS CONSTRUCTION LIST

No.	Description	Qty. Used	Materials	Remarks
1	Case	1	Polycarbonate	Flammability: UL94V-2 or more
2	Inner Case	1	Polycarbonate	Flammability: UL94V-2 or more
3	PCB	1	CEM-3	Flammability: UL94V-0
4	Connector	1	175489-3	AMP (Natural)
5	Light Emitting Diode	1	-	GaAs Infrared Light Emitting Diode
6	Detector	1	-	Phototransistor

HANDLING NOTES

1. Careful attention should be made to avoid deformation of components.
2. Environmental air must be free from corrosive gasses such as hydrogen sulfide or salt water air.
3. Mount sensor away from direct sunlight and incandescent light.
4. The side with emitting and receiving elements should be handled very carefully.
5. Insert and remove connectors at room temperature only.
6. Degrading LED radiant power should be addressed if sensor is used repeatedly over a long period of time.
7. This product was designed for use in the following applications:

OA equipment, video equipment, consumer electronics, communication equipment, measuring equipment, and control equipment.

When designing a system for safety and reliability, be sure to incorporate fail-safe and other appropriate measures.

FOOTNOTES

*1: $T_a > 25\text{ }^{\circ}\text{C}$

*2: $?? \leq 100\mu\text{s}$; $?? = 100\text{ Hz}$

*3: ??

*4:

